TOSHIBA

### TOSHIBA DIODE SILICON EPITAXIAL SCHOTTKY BARRIER TYPE

# J D H 2 S O 1 T

**UHF BAND MIXER** 

Unit in mm

Suitable for reducing set's size as a result from enabling highdensity mounting due to 2-pin small packages.

#### MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Maximum (Peak) Reverse Voltage	$v_{ m RM}$	5	V
Foward Current	${ m I_F}$	30	mA
Junction Temperature	$\mathrm{T_{j}}$	125	$^{\circ}\mathrm{C}$
Storage Temperature Range	$\mathrm{T_{stg}}$	-55~125	$^{\circ}\mathrm{C}$

0.55 0.55 0.55 0.55 0.55 0.50 0.55 0.50 0.55 0.50 0.55 0.50	
TESC	
JEDEC —	
EIAJ —	
TOSHIBA 1-1H1A	
Waimb4 . 0.0012 m	

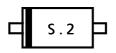
Weight: 0.0013 g

## ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Forward Voltage	$V_{\mathbf{F}}$	$I_{ m F}=2~{ m mA}$	_	0.25	_	V
Forward Current	$I_{\mathbf{F}}$	$V_{\mathbf{F}} = 0.5 V$	30	_	_	mA
Reverse Current	$I_{ m R}$	$V_R = 0.5 V$	_	_	25	$\mu$ <b>A</b>
Capacitance	$\mathrm{C}_{\mathrm{T}}$	$V_R = 0.2 V, f = 1 MHz$	_	0.6	_	pF

Signal level when capacitance is measured:  $Vsig = 20 \, mV_{rms}$ 

#### MARKING



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